

Printed: Oct 11, 2021

							2			3			
	PRODUCT NO.	POS	DIM X	DIM Y	DIM Z	DIM A	DIM B	DIM W	POL. POS	CONTACT PLATING	SOLDERTAIL PLATII		
	92813-001	2 X I 9	36	38	34	3.4	5.4	2.1	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0 0 2	2 X 8	4	16	12	3.4	5.4	2.1	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0 0 3	2XI5	28	30	26	3.5	6.5	2.4	-	0.38um MIN GXT	0.38um MIN GXT		
А	- 0 0 4	2 X 7	12	4	10	3.4	2.0	2.0	-	0.38um MIN Au	0.38um MIN Au		
	- 0 0 5	2 X 8	4	16	12	3.4	2.0	2.0	-	0.38um MIN Au	0.38um MIN Au		
	- 0 0 6	2 X I 2	22	24	20	3.6	5.5	2.1	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0 0 7	2 X 2 0	38	40	36	4.0	9.5	2.1	-	0.38um MIN GXT	0.38um MIN GXT		
	- 008	2 X 4	6	8	4	5.5	2.0	2.1	-	0.38um MIN Au	0.38um MIN Au		
	- 0 0 9	2 X 8	4	6	12	4.7	2.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0   0	2 X I 2	22	24	20	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0	2 X I O	18	20	16	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0   2	2 X I 6	30	32	28	4.0	2.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
В	- 0   3	2 X 5	8	10	6	3.5	0	2.0	-	0.76um MIN GXT	0.76um MIN GXT		
	- 0   4	2 X 4	6	8	4	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
	-0 5	2 X I 5	28	30	26	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
	-0 6	2 X I 3	24	26	22	4.0	4.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0   7	2XI8	34	36	32	4.0	4.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
77	- 0   8	2 X 6	10	12	8	2.8	Ι.Ο	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
Amphenol	- 0   9	2 X I 5	28	30	26	6.0	4.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT		
Ţ Ţ	- 0 2 0	2XI5	28	30	26	4.0	6.0	1.8	-	0.38um MIN GXT	0.38um MIN GXT		
Ē	- 0 2	2 X I 3	24	26	22	4.0	2.0	1.8	-	0.38um MIN GXT	0.38um MIN GXT		
▲ C	- 0 2 2	2 X I 4	26	28	24	2.0	6.5	2.4	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0 2 3	2X25	48	50	46	4.0	5.4	2.1	-	0.38um MIN GXT	0.38um MIN GXT		
	- 0 2 4	2XI5	28	30	26	3.4	2.0	2.0	-	0.38um MIN Au	0.38um MIN Au		
Б	- 0 2 5	2 X 3	4	6	2	4.0	2.0	2.0	-	0.76um MIN Au	0.76um MIN Au		
orati	- 0 2 6	2 X I 3	24	26	22	4.0	4.0	2.1	-	0.76um MIN GXT	0.76um MIN GXT		
Corp	- 027	2 X 4	6	8	4	4.65	8.7	2.0	-	0.38um MIN Au	0.38um MIN Au		
<b>2020 Amphenol Corporation</b>										dr wcadmin, wcadm 20	10/11/01 projection		
0 <b>50</b>													

3					4		
ITACT PLATING	SOLDERT	AIL PLATI	NG MAT	ERIAL			
38um MIN GXT	0.38u	m MIN GXT	SEE	NOTE I			
38um MIN GXT	0.38u	m MIN GXT		<b>A</b>			
38um MIN GXT	0.38u	m MIN GXT			-		
38um MIN Au	0.38	um MIN Au			_		
38um MIN Au	0.38	um MIN Au					
38um MIN GXT	0.38u	m MIN GXT			_		
38um MIN GXT	0.38u	m MIN GXT			_		
38um MIN Au	0.38	um MIN Au					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
76um MIN GXT	0.76u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					F
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN GXT	0.38u	m MIN GXT					
38um MIN Au	0.38	um MIN Au					
76 um MIN Au	0.76	um MIN Au					
76um MIN GXT	0.76u	m MIN GXT		¥			
38um MIN Au	0.38	um MIN Au	SEE	NOTE I			ŀ
76um MIN GXT 38um MIN Au	0.76u	m MIN GXT		NOTE I	-		
e n g Yuan-Yuan Bao 20	10/11/01 21/09/29	projection	M	VI L	size A 3	scale  0:	
chr appr Tim Yao 20	21/10/11	product family	M		ecn no rel level	Released	
	ITFK II	R / R		0 C			rev
<sup>·</sup> FCi 🗄		H LOCATOR		0 ≥ 2	9281.	3	BC
Viri I							

Creo File:ELX-WC-A3C,REV F,2020-12-21

2

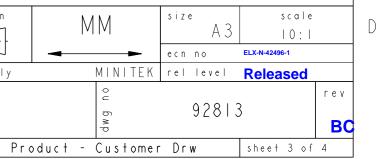
Л	
4	

			2					3		4				
	PRODUCT NO.	POS	DIM X	DIM Y	DIM Z	DIM A	DIM B	DIM W	POL. POS	CONTACT PLATING	SOLDERTAIL PLA	TING	MATERIAL	
	92813-028	2 X 5	8	10	6	4.0	2.0	2.0	-	0.76um MIN GXT	0.76um MIN G	ΧТ	SEE NOTE I	
	- 0 2 9	2 X 2 2	42	44	40	4.0	6.0	2.0	-	0.38um MIN GXT	0.38um MIN G	ΧТ	SEE NOTE I	
	- 0 3 0	2 X 7	12	4	0	3.4	2.0	2.0	-	0.38um MIN GXT	0.38um MIN G	ΧТ	SEE NOTE I	
А	- 0 3	2XI5	28	30	26	3.4	2.0	2.0	-	0.38um MIN GXT	0.38um MIN G	ΧТ	SEE NOTE I	
	- 0 3 2	2 X 4	6	8	4	4.5	3.0	2.25	-	0.76um MIN Au	2.54um MIN 100	%Sn	SEE NOTE I	
	- 0 3 3	2 X I 6	30	32	28	4.1	3.7	2.25	-	0.76um MIN Au	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 3 4	2 X I 6	30	32	28	3.7	0.5	2.25	-	0.76um MIN Au	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 3 5	2 X 4	6	8	4	4.0	4.4	2.00	-	0.38um MIN Au	0.38um MIN A	A u	SEE NOTE I	
	- 0 3 6	2 X 2 0	38	32	28	4.0	6.5	2.00	-	0.38um MIN GXT	0.38um MIN G	ΧТ	SEE NOTE I	
	- 0 3 7	2 X I 4	26	28	24	4.0	9.5	2.1	-	0.76um MIN Au	2.54um MIN 100	%Sn	SEE NOTE I	
	- 0 3 8	2 X I 4	26	28	24	4.0	9.5	2.1	-	0.76um MIN GXT	2.54um MIN 100	%Sn	SEE NOTE I	
	- 0 3 9	2 X I O	18	20	16	4.1	3.75	2.1	-	0.76um MIN GXT	2.54um MIN 100	%Sn	SEE NOTE I	
В	- 0 4 0	2 X 5	8	10	6	4.0	5.0	2.1	-	0.76um MIN GXT	2.54um MIN 100	%Sn	SEE NOTE I	
	- 0 4	2XI5	28	30	26	4.0	5.5	2.0	-	0.76um MIN GXT	0.76um MIN G	ХΤ	SEE NOTE I	
	- 0 4 2	2 X 8	4	16	12	4.0	11.5	2.1	-	0.38um MIN GXT	0.38um MIN G	ΧТ	SEE NOTE I	
	- 0 4 3	2 X 2 2	42	44	40	4.0	11.5	2.1	-	0.38um MIN GXT	0.38um MIN G	ΧТ	SEE NOTE I	
	- 0 4 7	2 X 7	12	4	10	4.0	0.5	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
77	- 0 4 9	2 X I 4	26	28	24	4.0	0.5	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
<b>SC</b>	- 0 5 0	2 X 5	8	10	6	4.1	3.75	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
Amphen	- 0 5	2 X 4	6	8	4	3.8	4.03	2.1	-	GOLD FLASH	2.54um MIN 100	% Sn	SEE NOTE I	
Ĭ	- 0 5 2	2 X 4	6	8	4	3.43	7.3	2.1	-	GOLD FLASH	2.54um MIN 100	% Sn	SEE NOTE I	

C 2020 Amphenol Corporation

dr	wcadmin, wcad	m		2010/11/01				project			
eng	Yuan-Yuan Bad		2021/09/29					F	$\leq$		
chr	-		-				$  \Psi \subseteq$				
appr	Tim Yao			2021/10/11				product fa			
Amp	ohenol FCi	⊕ 	MI	NITI	ΞK		R	/ R			
		+ ;	SMT	STR	HDR	WIT	Н	LOCAT	OF	{	
amphe	nol-icc.com	cat	. no					-			
			3		PDS	: Rev	:BC	;			

2



## STATUS:Released

Printed: Oct 11, 2021

А

В

С

	NOT	ES:		
	Ι.	MATERIAL: BODY : HIGH TEMPERATURE THERMOPLASTIC, UL 94V-0 NATURAL PIN : COPPER ALLOY	12.	THE HOUS TEMPERATU APPLICATI
A	2.	TOLERANCE UNLESS OTHERWISE NOTED $\pm$ 0.25	3.	THIS PROE OTHER COL
	3.	DIM 1.0 $\pm$ 0.15 APPLIES TO MOLDED SIDE(S) ONLY. IF SIDE(S) ARE BROKEN, DIM 1.5 MAX APPLIES.	4.	PN 92813- PICK-UP(L
	4.	RECESS APPLIES TO MOLDED SIDE(S) ONLY.		
	5.	POLARISATION BY OMISSION OF PIN. POSITION REFER TO TABLE.		
	6.	P/N 928I3-XXXT TO BE PACKED IN TUBE.	1	
В	7.	P/N 928I3-0IITC, 0I4TC, 023TC & 024TC TO BE PACKED IN TUBE WITH PICK-UP CAP INSTALLED IN THE CENTRE OF THE PRODUCT. SEE FIG. I.	I	. 0
	8.	P/N 928I3-XXXTR TO BE PACKED IN TAPE & REEL WITH PICK-UP CAP INSTALLED IN THE CENTRE OF THE PRODUCT. SEE FIG. I.		↓ ↓ ↓.5
phenol FCi	9.	PRODUCT PART NUMBER DESCRIPTIONS: 92813 - XXX LF LEAD FREE. SEE NOTE 10		¥
<b>Amb</b>	0.	NO. OF POSITIONS (RANDOM) P/N:928I3-XXXLF IS SAME TO 928I3-XXX. THE SUFFIX 'LF' IS ADDED JUST FOR EASY LEAD FREE IDENTIFICATION.		
ы	.	THE HOUSING WILL WITHSTAND EXPOSURE TO 255°C PEAK TEMPERATURE FOR IO SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN		RECOMM
Corporati				
Amphenol				
© 2020 Amphenol Corporation				dr wead eng Yuar chr - gppr Tim
				Amphe F

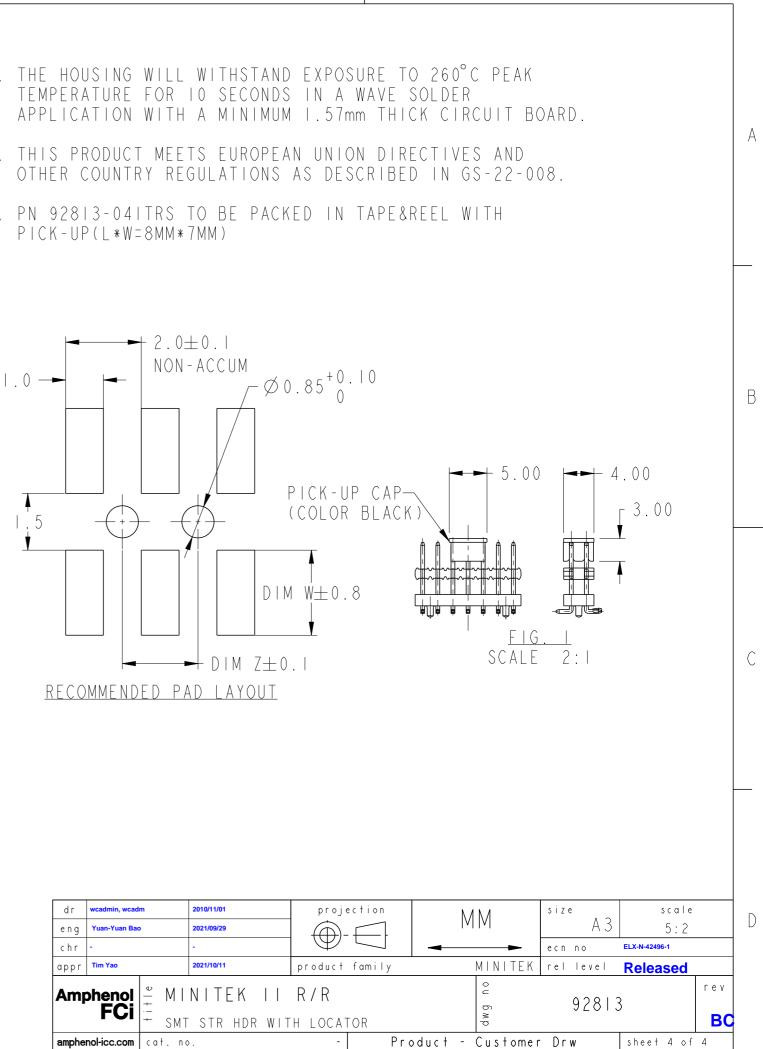
Creo File:ELX-WC-A3C,REV F,2020-12-21

2

2

3

- (L \* W = 8 M M \* 7 M M)



STATUS:Released

Printed: Oct 11, 2021

dr	wcadmin, wcad	m	2010/11/01			projectio				
e n g	Yuan-Yuan Bac	<b>)</b>	2021/09/29			6	Ð-	F		
chr	-		-	C						
appr	Tim Yao		2021/10/11	product fami						
Amp	ohenol FCi	● + + + + SMT	NITI str	E K hdr	 wit	R/F h lo	<b>}</b> ⊂ A 1	ſOF	}	
amphe	nol-icc.com	cat.no	).				-		ŀ	
		3		PDS	: Rev	:BC				